

## LMV1090 Dual Input, Far Field Noise Suppression Microphone Amplifier

Check for Samples: [LMV1090](#)

### FEATURES

- No Loss of Voice Intelligibility
- No Added Processing Delay
- Low Power Consumption
- Differential Outputs
- Excellent RF Immunity
- Adjustable 12 - 54dB Gain
- Shutdown Function
- Space-Saving 16-Bump DSBGA Package

### APPLICATIONS

- Mobile Headset
- Mobile and Handheld Two-Way Radios
- Bluetooth and Other Powered Headsets
- Hand-held Voice Microphones
- Cell Phones

### KEY SPECIFICATIONS

- Far Field Noise Suppression Electrical (FFNS<sub>E</sub> at f = 1kHz): 34dB (typ)
- SNRIE 26dB (typ)
- Supply Current: 600µA (typ)
- Standby Current 0.1µA (typ)
- Signal-to-Noise Ratio (Voice band): 65dB (typ)
- Total Harmonic Distortion + Noise: 0.1% (typ)
- PSRR (217Hz): 99dB (typ)

### DESCRIPTION

The LMV1090 is a fully analog dual differential input, differential output, microphone array amplifier designed to reduce background acoustic noise, while delivering superb speech clarity in voice communication applications.

The LMV1090 preserves near-field voice signals within 4cm of the microphones while rejecting far-field acoustic noise greater than 50cm from the microphones. Up to 20dB of far-field rejection is possible in a properly configured and using  $\pm 0.5$ dB matched microphones.

Part of the PowerWise™ family of energy efficient solutions, the LMV1090 consumes only 600µA of supply current providing superior performance over DSP solutions consuming greater than ten times the power.

The dual microphone inputs and the processed signal output are differential to provide excellent noise immunity. The microphones are biased with an internal low-noise bias supply.

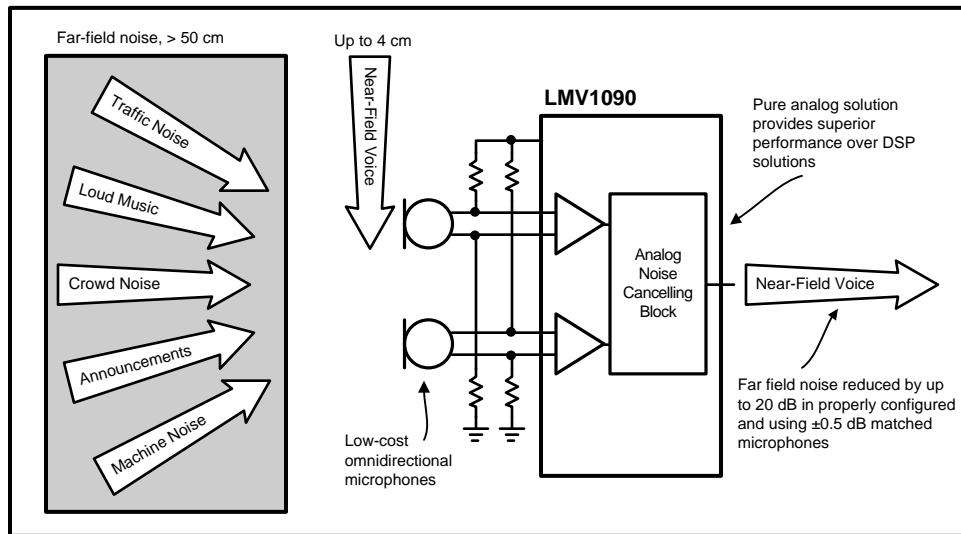


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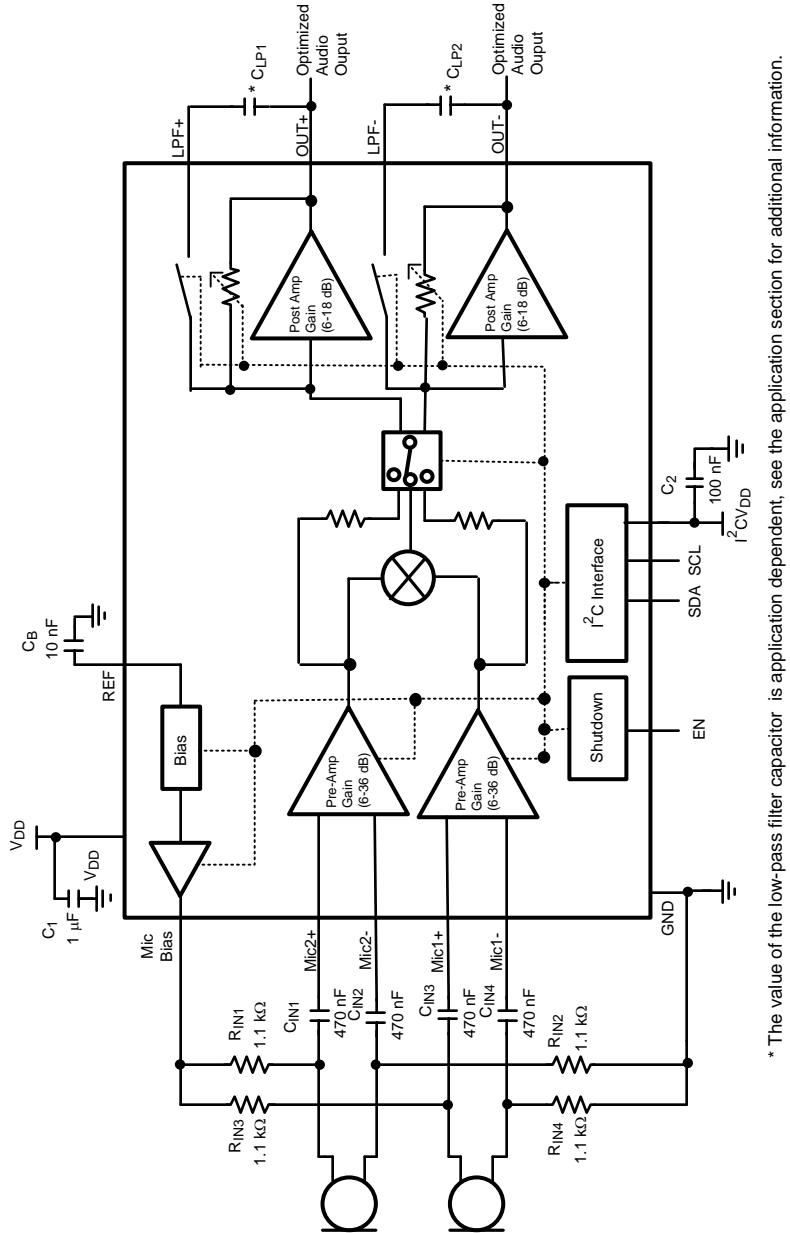
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## System Diagram



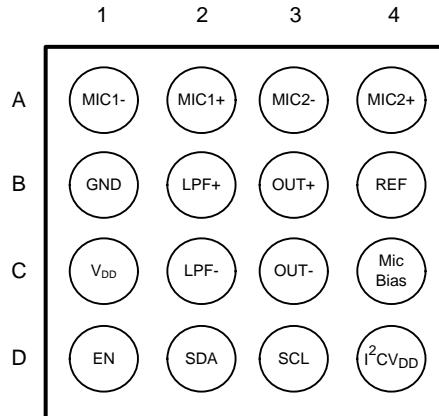
## Typical Application



\* The value of the low-pass filter capacitor is application dependent, see the application section for additional information.

**Figure 1. Typical Dual Microphone Far Field noise Cancelling Application**

## Connection Diagram



**Figure 2. 16-Bump DSBGA (Top View)**  
See YZR0016 Package

## PIN DESCRIPTIONS

| Bump Number | Pin Name                        | Pin Function                        | Pin Type             |
|-------------|---------------------------------|-------------------------------------|----------------------|
| A1          | MIC1–                           | Microphone 1 negative input         | Analog Input         |
| A2          | MIC1+                           | Microphone 1 positive input         | Analog Input         |
| A3          | MIC2–                           | Microphone 2 negative input         | Analog Input         |
| A4          | MIC2+                           | Microphone 2 positive input         | Analog Input         |
| B1          | GND                             | Amplifier ground                    | Ground               |
| B2          | LPF+                            | Low Pass Filter for positive output | Analog Input         |
| B3          | OUT+                            | Positive optimized audio output     | Analog Output        |
| B4          | REF                             | Reference voltage de-coupling       | Analog Reference     |
| C1          | V <sub>DD</sub>                 | Power supply                        | Supply               |
| C2          | LPF-                            | Low Pass Filter for negative output | Analog Input         |
| C3          | OUT-                            | Negative optimized audio output     | Analog Output        |
| C4          | Mic Bias                        | Microphone Bias                     | Analog Output        |
| D1          | EN                              | Chip enable                         | Digital input        |
| D2          | SDA                             | I <sup>2</sup> C data               | Digital Input/Output |
| D3          | SCL                             | I <sup>2</sup> C clock              | Digital Input        |
| D4          | I <sup>2</sup> CV <sub>DD</sub> | I <sup>2</sup> C power supply       | Supply               |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

|   |                                  |
|---|----------------------------------|
| Supply Voltage  | 6.0V                             |
| Storage Temperature   | -85°C to +150°C                  |
| Power Dissipation <sup>(3)</sup>  | Internally Limited               |
| ESD Rating <sup>(4)</sup>   | 2000V                            |
| ESD Rating <sup>(5)</sup>   | 200V                             |
| CDM   | 500V                             |
| Junction Temperature (T <sub>JMAX</sub> )   | 150°C                            |
| Mounting Temperature  | Infrared or Convection (20 sec.) |
| Thermal Resistance  | θ <sub>JA</sub> (DSBGA)          |
| Soldering Information See <a href="#">AN-1112</a> "microSMD Wafers Level Chip Scale Package." |                                  |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) The maximum power dissipation must be de-rated at elevated temperatures and is dictated by T<sub>JMAX</sub>, θ<sub>JC</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable power dissipation is P<sub>DMAX</sub> = (T<sub>JMAX</sub> – T<sub>A</sub>) / θ<sub>JA</sub> or the number given in the *Absolute Maximum Ratings*, whichever is lower. For the LMV1090, T<sub>JMAX</sub> = 150°C and the typical θ<sub>JA</sub> for this DSBGA package is 70°C/W. Refer to the Thermal Considerations section for more information.
- (4) Human body model, applicable std. JESD22-A114C.
- (5) Machine model, applicable std. JESD22-A115-A.

## Operating Ratings<sup>(1)</sup>

|   |   |
|---|---|
| Supply Voltage  | 2.7V ≤ V <sub>DD</sub> ≤ 5.5V                 |
| I <sup>2</sup> CV <sub>DD</sub> Supply Voltage <sup>(2)</sup> | 1.7V ≤ I <sup>2</sup> CV <sub>DD</sub> ≤ 5.5V |
| T <sub>MIN</sub> ≤ T <sub>A</sub> ≤ T <sub>MAX</sub>          | -40°C ≤ T <sub>A</sub> ≤ +85°C                |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The voltage at I<sup>2</sup>CV<sub>DD</sub> must not exceed the voltage on V<sub>DD</sub>.

## Electrical Characteristics 3.3V<sup>(1)(2)</sup>

Unless otherwise specified, all limits specified for T<sub>A</sub> = 25°C, V<sub>DD</sub> = 3.3V, V<sub>IN</sub> = 18mV<sub>P-P</sub>, f = 1kHz, EN = V<sub>DD</sub>, Pre Amp gain = 20dB, Post Amp gain = 6dB, R<sub>L</sub> = 100kΩ, and C<sub>L</sub> = 4.7pF, f = 1kHz pass through mode.

| Symbol          | Parameter                  | Conditions   | LMV1090                |                      | Units (Limits)          |
|-----------------|----------------------------|--|------------------------|----------------------|-------------------------|
|                 |                            |  | Typical <sup>(3)</sup> | Limit <sup>(4)</sup> |                         |
| SNR             | Signal-to-Noise Ratio      | V <sub>IN</sub> = 18mV <sub>P-P</sub><br>A-weighted, Audio band    | 63                     |                      | dB                      |
|                 |                            | V <sub>OUT</sub> = 18V <sub>P-P</sub> ,<br>voice band (300–3400Hz) | 65                     |                      | dB                      |
| e <sub>N</sub>  | Input Referred Noise level | A-Weighted   | 5                      |                      | μV <sub>RMS</sub>       |
| V <sub>IN</sub> | Maximum Input Signal       | THD+N < 1%, Pre Amp Gain = 6dB                                     | 880                    | 820                  | mV <sub>P-P</sub> (min) |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list specified specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not ensured.
- (3) Typical values represent most likely parametric norms at T<sub>A</sub> = +25°C, and at the Recommended Operation Conditions at the time of product characterization and are not ensured.
- (4) Datasheet min/max specification limits are ensured by test, or statistical analysis.

## Electrical Characteristics 3.3V<sup>(1)(2)</sup> (continued)

Unless otherwise specified, all limits specified for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ ,  $V_{IN} = 18\text{mV}_{\text{P-P}}$ ,  $f = 1\text{kHz}$ ,  $EN = V_{DD}$ , Pre Amp gain = 20dB, Post Amp gain = 6dB,  $R_L = 100\text{k}\Omega$ , and  $C_L = 4.7\text{pF}$ ,  $f = 1\text{kHz}$  pass through mode.

| Symbol                     | Parameter  | Conditions  | LMV1090                |                      | Units (Limits)                              |
|----------------------------|--|---|------------------------|----------------------|---|
|                            |  |   | Typical <sup>(3)</sup> | Limit <sup>(4)</sup> |   |
| $V_{OUT}$                  | Maximum AC Output Voltage                          | Differential Out+, Out- THD+N < 1%  | 1.2                    | 1.1                  | $V_{\text{RMS}}$ (min)                      |
|                            | DC Level at Outputs                                | Out+, Out-  | 820                    |                      | mV  |
| THD+N                      | Total Harmonic Distortion + Noise                  | Differential Out+ and Out-  | 0.1                    | 0.2                  | % (max)                                     |
| $Z_{IN}$                   | Input Impedance                                    |   | 142                    |                      | $\text{k}\Omega$                            |
| $Z_{OUT}$                  | Output Impedance (Differential)                    |   | 220                    |                      | $\Omega$                                    |
| $Z_{LOAD}$                 | Load Impedance (Out+, Out-) <sup>(5)</sup>         | $R_{\text{LOAD}}$<br>$C_{\text{LOAD}}$  |                        | 10<br>100            | $\text{k}\Omega$ (min)<br>$\text{pF}$ (max) |
| $A_M$                      | Microphone Preamplifier Gain Range                 | minimum<br>maximum  | 6<br>36                |                      | dB<br>dB                                    |
| $A_{\text{MR}}$            | Microphone Preamplifier Gain Adjustment Resolution |   | 2                      | 1.7<br>2.3           | dB (min)<br>dB (max)                        |
| $A_P$                      | Post Amplifier Gain Range                          | minimum<br>maximum  | 6<br>18                |                      | dB<br>dB                                    |
| $A_{\text{PR}}$            | Post Amplifier Gain Resolution                     |   | 3                      | 2.6<br>3.4           | dB (min)<br>dB (max)                        |
| FFNSE                      | Far Field Noise Suppression Electrical             | $f = 1\text{kHz}$ (See <a href="#">Test Methods</a> )<br>$f = 300\text{Hz}$ (See <a href="#">Test Methods</a> ) | 34<br>42               | 26                   | dB<br>dB                                    |
| SNRI <sub>E</sub>          | Signal-to-Noise Ratio Improvement Electrical       | $f = 1\text{kHz}$ (See <a href="#">Test Methods</a> )<br>$f = 300\text{Hz}$ (See <a href="#">Test Methods</a> ) | 26<br>33               | 18                   | dB<br>dB                                    |
| PSRR                       | Power Supply Rejection Ratio                       | Input Referred, Input AC grounded   |                        |                      |   |
|                            |  | $f_{\text{RIPPLE}} = 217\text{Hz}$ ( $V_{\text{RIPPLE}} = 100\text{mV}_{\text{P-P}}$ )                          | 99                     | 85                   | dB (min)                                    |
|                            |  | $f_{\text{RIPPLE}} = 1\text{kHz}$ ( $V_{\text{RIPPLE}} = 100\text{mV}_{\text{P-P}}$ )                           | 95                     | 80                   | dB (min)                                    |
| CMRR                       | Common Mode Rejection Ratio                        | input referred  | 60                     |                      | dB  |
| $V_{BM}$                   | Microphone Bias Supply Voltage                     | $I_{\text{BIAS}} = 1.2\text{mA}$  | 2.0                    | 1.85<br>2.15         | V (min)<br>V (max)                          |
| $e_{VBM}$                  | Mic bias noise voltage on $V_{\text{REF}}$ pin     | A-Weighted, $C_B = 10\text{nF}$   | 7                      |                      | $\mu\text{V}_{\text{RMS}}$                  |
| $I_{DDQ}$                  | Supply Quiescent Current                           | $V_{IN} = 0\text{V}$  | 0.60                   | 0.80                 | mA (max)                                    |
| $I_{DD}$                   | Supply Current                                     | $V_{IN} = 25\text{mV}_{\text{P-P}}$ both inputs<br>Noise cancelling mode  | 0.60                   |                      | mA  |
| $I_{SD}$                   | Shut Down Current                                  | EN pin = GND  | 0.1                    | 0.7                  | $\mu\text{A}$ (max)                         |
| $I_{DD}\text{I}^2\text{C}$ | $\text{I}^2\text{C}$ supply current                | $\text{I}^2\text{C}$ Idle Mode  | 25                     | 100                  | nA (max)                                    |
| $T_{ON}$                   | Turn-On Time <sup>(6)</sup>                        |   |                        | 40                   | ms (max)                                    |
| $T_{OFF}$                  | Turn-Off Time <sup>(6)</sup>                       |   |                        | 60                   | ms (max)                                    |

(5) Ensured by design.

(6) Ensured by design.

## Electrical Characteristics 5.0V<sup>(1)(2)</sup>

Unless otherwise specified, all limits ensured for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{IN} = 18\text{mV}_{\text{P-P}}$ ,  $EN = V_{DD}$ , Pre Amp gain = 20dB, Post Amp gain = 6dB,  $R_L = 100\text{k}\Omega$ , and  $C_L = 4.7\text{pF}$ ,  $f = 1\text{kHz}$  pass through mode.

| Symbol            | Parameter   | Conditions  | LMV1090                |                      | Units<br>(Limits)                                      |
|-------------------|---|---|------------------------|----------------------|--|
|                   |   |   | Typical <sup>(3)</sup> | Limit <sup>(4)</sup> |  |
| SNR               | Signal-to-Noise Ratio                                 | $V_{IN} = 18\text{mV}_{\text{P-P}}$<br>A-weighted, Audio band   | 63                     |                      | dB   |
|                   |   | $V_{OUT} = 18\text{mV}_{\text{P-P}}$ ,<br>voice band (300–3400Hz)   | 65                     |                      | dB   |
| $e_N$             | Input Referred Noise level                            | A-Weighted  | 5                      |                      | $\mu\text{V}_{\text{RMS}}$                             |
| $V_{IN}$          | Maximum Input Signal                                  | $\text{THD+N} < 1\%$  | 880                    | 820                  | $\text{mV}_{\text{P-P}} \text{ (min)}$                 |
| $V_{OUT}$         | Maximum AC Output Voltage                             | $f = 1\text{kHz}$ , $\text{THD+N} < 1\%$<br>between differential output   | 1.2                    | 1.1                  | $\text{V}_{\text{RMS}} \text{ (min)}$                  |
|                   | DC Output Voltage                                     |   | 820                    |                      | mV   |
| THD+N             | Total Harmonic Distortion + Noise                     | Differential Out+ and Out-  | 0.1                    | 0.2                  | % (max)  |
| $Z_{IN}$          | Input Impedance                                       |   | 142                    |                      | $\text{k}\Omega$                                       |
| $Z_{OUT}$         | Output Impedance                                      |   | 220                    |                      | $\Omega$   |
| $A_M$             | Microphone Preamplifier Gain Range                    | minimum<br>maximum  | 6<br>36                |                      | $\text{dB}$<br>$\text{dB}$                             |
| $A_{MR}$          | Microphone Preamplifier Gain Adjustment Resolution    |   | 2                      | 1.7<br>2.3           | $\text{dB} \text{ (min)}$<br>$\text{dB} \text{ (max)}$ |
| $A_P$             | Post Amplifier Gain Range                             | minimum<br>maximum  | 6<br>18                |                      | $\text{dB}$<br>$\text{dB}$                             |
| $A_{PR}$          | Post Amplifier Gain Adjustment Resolution             |   | 3                      | 2.6<br>3.4           | $\text{dB} \text{ (min)}$<br>$\text{dB} \text{ (max)}$ |
| FFNSE             | Far Field Noise Suppression Electrical                | $f = 1\text{kHz}$ (See <a href="#">Test Methods</a> )<br>$f = 300\text{Hz}$ (See Test Method)                   | 34<br>42               | 26                   | $\text{dB}$<br>$\text{dB}$                             |
| SNRI <sub>E</sub> | Signal-to-Noise Ratio Improvement Electrical          | $f = 1\text{kHz}$ (See <a href="#">Test Methods</a> )<br>$f = 300\text{Hz}$ (See <a href="#">Test Methods</a> ) | 26<br>33               | 18                   | $\text{dB}$<br>$\text{dB}$                             |
| PSRR              | Power Supply Rejection Ratio                          | Input Referred, Input AC grounded   |                        |                      |  |
|                   |   | $f_{\text{RIPPLE}} = 217\text{Hz}$ ( $V_{\text{RIPPLE}} = 100\text{mV}_{\text{P-P}}$ )                          | 99                     | 85                   | $\text{dB} \text{ (min)}$                              |
|                   |   | $f_{\text{RIPPLE}} = 1\text{kHz}$ ( $V_{\text{RIPPLE}} = 100\text{mV}_{\text{P-P}}$ )                           | 95                     | 80                   | $\text{dB} \text{ (min)}$                              |
| CMRR              | Common Mode Rejection Ratio                           | input referred  | 60                     |                      | $\text{dB}$  |
| $V_{BM}$          | Microphone Bias Supply Voltage                        | $I_{BIAS} = 1.2\text{mA}$   | 2.0                    | 1.85<br>2.15         | $\text{V} \text{ (min)}$<br>$\text{V} \text{ (max)}$   |
| $e_{VBM}$         | Microphone bias noise voltage on $V_{\text{REF}}$ pin | A-Weighted, $C_B = 10\text{nF}$   | 7                      |                      | $\mu\text{V}_{\text{RMS}}$                             |
| $I_{DDQ}$         | Supply Quiescent Current                              | $V_{IN} = 0\text{V}$  | 0.60                   | 0.80                 | mA (max)   |
| $I_{DD}$          | Supply Current  | $V_{IN} = 25\text{mV}_{\text{P-P}}$ both inputs<br>Noise cancelling mode  | 0.60                   |                      | mA   |
| $I_{SD}$          | Shut Down Current                                     | $EN$ pin = GND  | 0.1                    |                      | $\mu\text{A}$  |
| $I_{DDI^2C}$      | $I^2\text{C}$ supply current                          | $I^2\text{C}$ Idle Mode   | 25                     | 100                  | nA (max)   |
| $T_{ON}$          | Turn On Time <sup>(5)</sup>                           |   |                        | 40                   | mA (max)   |
| $T_{OFF}$         | Turn Off Time <sup>(5)</sup>                          |   |                        | 60                   | ms (max)   |

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The voltage at  $I^2\text{C}V_{DD}$  must not exceed the voltage on  $V_{DD}$ .
- (3) Typical values represent most likely parametric norms at  $T_A = +25^\circ\text{C}$ , and at the Recommended Operation Conditions at the time of product characterization and are not ensured.
- (4) Datasheet min/max specification limits are ensured by test, or statistical analysis.
- (5) Ensured by design.

### Digital Interface Characteristics $I^2C_V_{DD} = 2.2V$ to $5.5V^{(1)(2)}$

The following specifications apply for  $V_{DD} = 5.0V$  and  $3.3V$ ,  $T_A = 25^\circ C$ ,  $2.2V \leq I^2C_V_{DD} \leq 5.5V$ , unless otherwise specified.

| Symbol   | Parameter                 | Conditions   | LMV1090                |                          | Units (Limits) |
|----------|---------------------------|--------------|------------------------|--------------------------|----------------|
|          |                           |              | Typical <sup>(3)</sup> | Limits <sup>(4)(5)</sup> |                |
| $t_1$    | $I^2C$ Clock Period       |              |                        | 2.5                      | $\mu s$ (min)  |
| $t_2$    | $I^2C$ Data Setup Time    |              |                        | 100                      | ns (min)       |
| $t_3$    | $I^2C$ Data Stable Time   |              |                        | 0                        | ns (min)       |
| $t_4$    | Start Condition Time      |              |                        | 100                      | ns (min)       |
| $t_5$    | Stop Condition Time       |              |                        | 100                      | ns (min)       |
| $t_6$    | $I^2C$ Data Hold Time     |              |                        | 100                      | ns (min)       |
| $V_{IH}$ | $I^2C$ Input Voltage High | EN, SCL, SDA |                        | $0.7 \times I^2C_V_{DD}$ | V (min)        |
| $V_{IL}$ | $I^2C$ Input Voltage Low  | EN, SCL, SDA |                        | $0.3 \times I^2C_V_{DD}$ | V (max)        |

- (1) The Electrical Characteristics tables list specified specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not ensured.
- (2) The voltage at  $I^2C_V_{DD}$  must not exceed the voltage on  $V_{DD}$ .
- (3) Human body model, applicable std. JESD22-A114C.
- (4) Machine model, applicable std. JESD22-A115-A.
- (5) Datasheet min/max specification limits are ensured by test, or statistical analysis.

### Digital Interface Characteristics $I^2C_V_{DD} = 1.7V$ to $2.2V$

The following specifications apply for  $V_{DD} = 5.0V$  and  $3.3V$ ,  $T_A = 25^\circ C$ ,  $1.7V \leq I^2C_V_{DD} \leq 2.2V$ , unless otherwise specified.

| Symbol   | Parameter                 | Conditions   | LMV1090                |                          | Units (Limits) |
|----------|---------------------------|--------------|------------------------|--------------------------|----------------|
|          |                           |              | Typical <sup>(1)</sup> | Limits <sup>(2)</sup>    |                |
| $t_1$    | $I^2C$ Clock Period       |              |                        | 2.5                      | $\mu s$ (min)  |
| $t_2$    | $I^2C$ Data Setup Time    |              |                        | 250                      | ns (min)       |
| $t_3$    | $I^2C$ Data Stable Time   |              |                        | 0                        | ns (min)       |
| $t_4$    | Start Condition Time      |              |                        | 250                      | ns (min)       |
| $t_5$    | Stop Condition Time       |              |                        | 250                      | ns (min)       |
| $t_6$    | $I^2C$ Data Hold Time     |              |                        | 250                      | ns (min)       |
| $V_{IH}$ | $I^2C$ Input Voltage High | EN, SCL, SDA |                        | $0.7 \times I^2C_V_{DD}$ | V (min)        |
| $V_{IL}$ | $I^2C$ Input Voltage Low  | EN, SCL, SDA |                        | $0.3 \times I^2C_V_{DD}$ | V (max)        |

- (1) Typical values represent most likely parametric norms at  $T_A = +25^\circ C$ , and at the Recommended Operation Conditions at the time of product characterization and are not ensured.
- (2) Datasheet min/max specification limits are ensured by test, or statistical analysis.

## Test Methods

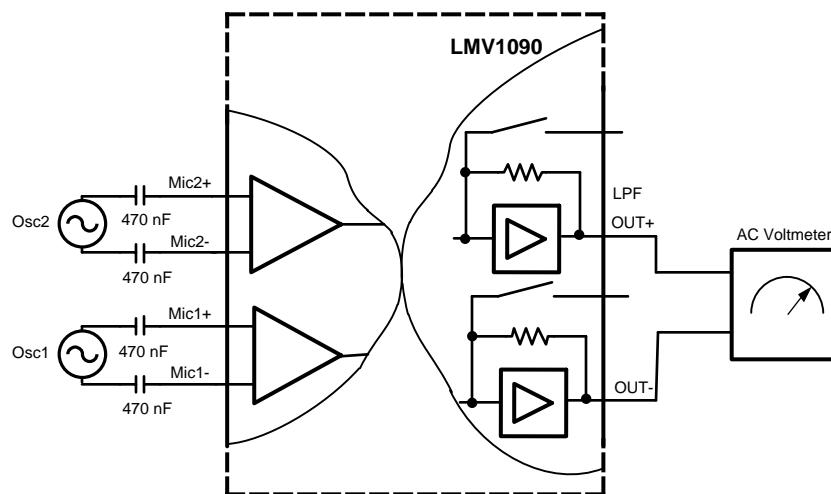


Figure 3.  $\text{FFNS}_E$ ,  $\text{NFSL}_E$ ,  $\text{SNRI}_E$  Test Circuit

### FAR FIELD NOISE SUPPRESSION ( $\text{FFNS}_E$ )

For optimum noise suppression the far field noise should be in a broadside array configuration from the two microphones (see [Figure 22](#)). Which means the far field sound source is equidistance from the two microphones. This configuration allows the amplitude of the far field signal to be equal at the two microphone inputs, however a slight phase difference may still exist. To simulate a real world application a slight phase delay was added to the  $\text{FFNS}_E$  test. The block diagram from [Figure 17](#) is used with the following procedure to measure the  $\text{FFNS}_E$ .

1. A sine wave with equal frequency and amplitude (25mV<sub>P-P</sub>) is applied to Mic1 and Mic2. Using a signal generator, the phase of Mic 2 is delayed by 1.1° when compared with Mic1.
2. Measure the output level in dBV (X)
3. Mute the signal from Mic2
4. Measure the output level in dBV (Y)
5.  $\text{FFNS}_E = Y - X \text{ dB}$

### NEAR FIELD SPEECH LOSS ( $\text{NFSL}_E$ )

For optimum near field speech preservation, the sound source should be in an endfire array configuration from the two microphones (see [Figure 23](#)). In this configuration the speech signal at the microphone closest to the sound source will have greater amplitude than the microphone further away. Additionally the signal at microphone further away will experience a phase lag when compared with the closer microphone. To simulate this, phase delay as well as amplitude shift was added to the  $\text{NFSL}_E$  test. The schematic from [Figure 17](#) is used with the following procedure to measure the  $\text{NFSL}_E$ .

1. A 25mV<sub>P-P</sub> and 17.25mV<sub>P-P</sub> (0.69\*25mV<sub>P-P</sub>) sine wave is applied to Mic1 and Mic2 respectively. Once again, a signal generator is used to delay the phase of Mic2 by 15.9° when compared with Mic1.
2. Measure the output level in dBV (X)
3. Mute the signal from Mic2
4. Measure the output level in dBV (Y)
5.  $\text{NFSL}_E = Y - X \text{ dB}$

### SIGNAL TO NOISE RATIO IMPROVEMENT ELECTRICAL ( $\text{SNRI}_E$ )

The  $\text{SNRI}_E$  is the ratio of  $\text{FFNS}_E$  to  $\text{NFSL}_E$  and is defined as:

$$\text{SNRI}_E = \text{FFNS}_E - \text{NFSL}_E \quad (1)$$

### Typical Performance Characteristics

Unless otherwise specified,  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , Input Voltage =  $18\text{mV}_{\text{P-P}}$ ,  $f = 1\text{ kHz}$ , pass through mode (Note 8), Pre Amp gain =  $20\text{dB}$ , Post Amp gain =  $6\text{dB}$ ,  $R_L = 100\text{k}\Omega$ , and  $C_L = 4.7\text{pF}$ .

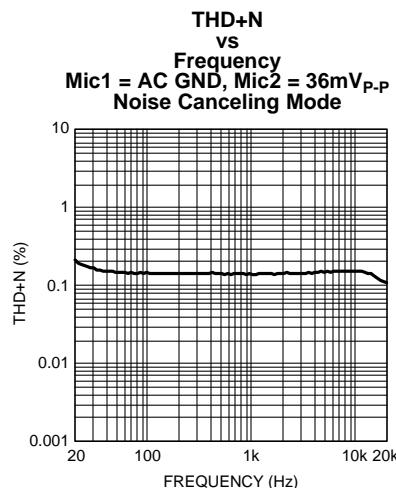


Figure 4.

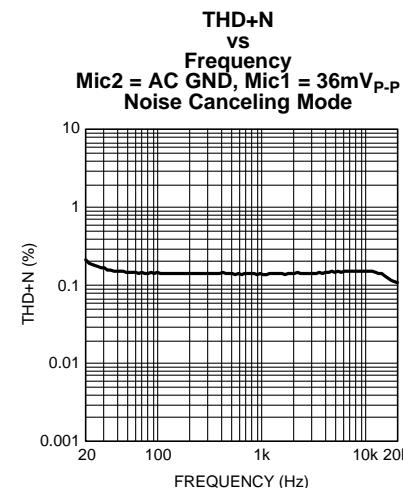


Figure 5.

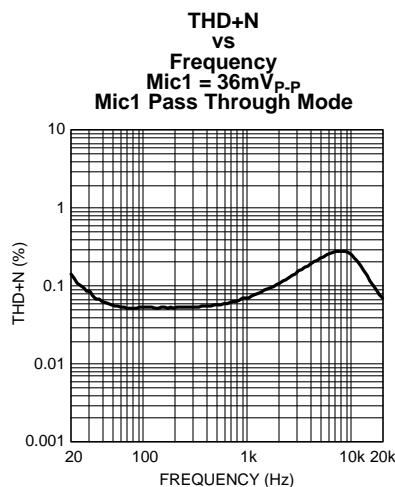


Figure 6.

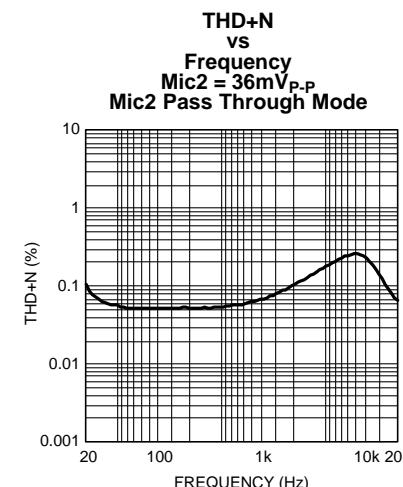


Figure 7.

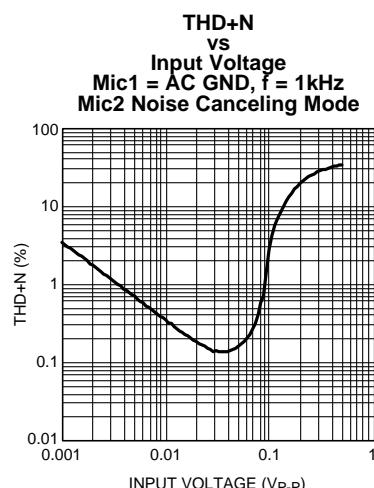


Figure 8.

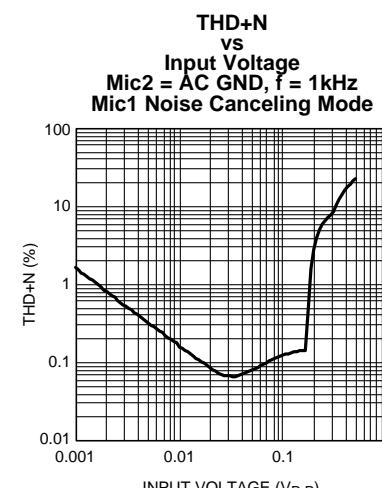


Figure 9.

### Typical Performance Characteristics (continued)

Unless otherwise specified,  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , Input Voltage =  $18\text{mV}_{\text{P-P}}$ ,  $f = 1\text{ kHz}$ , pass through mode (Note 8), Pre Amp gain =  $20\text{dB}$ , Post Amp gain =  $6\text{dB}$ ,  $R_L = 100\text{k}\Omega$ , and  $C_L = 4.7\text{pF}$ .

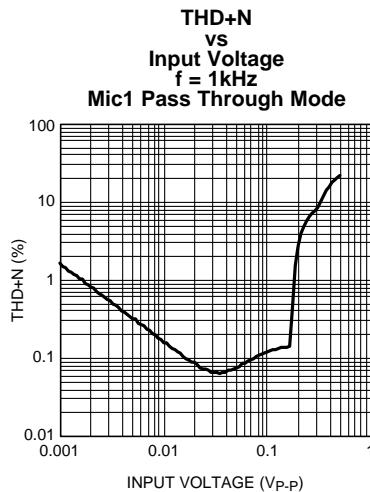


Figure 10.

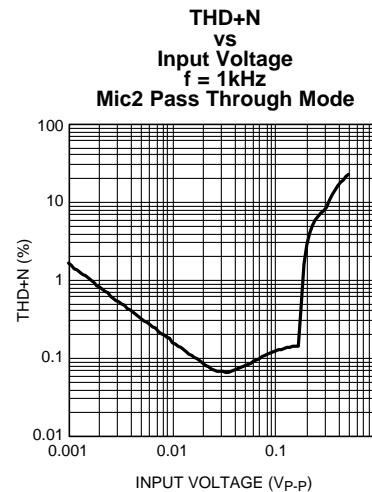


Figure 11.

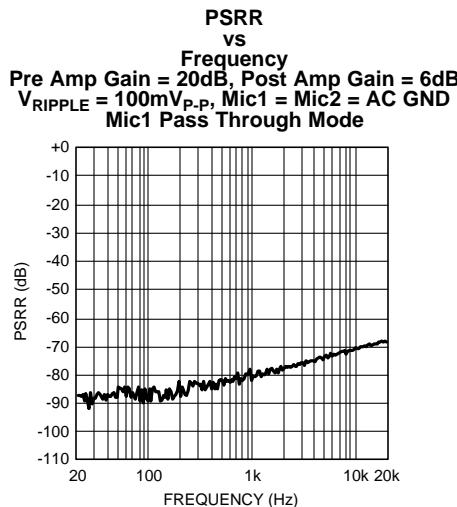


Figure 12.

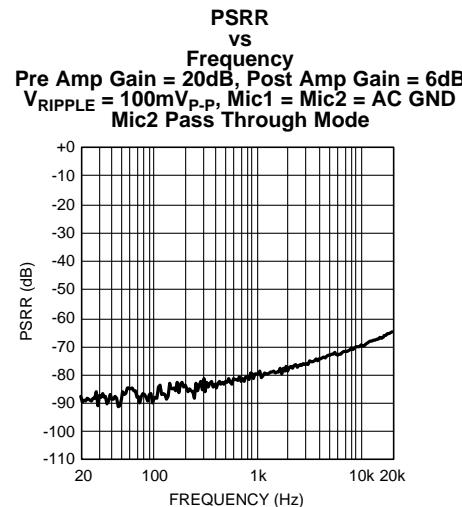


Figure 13.

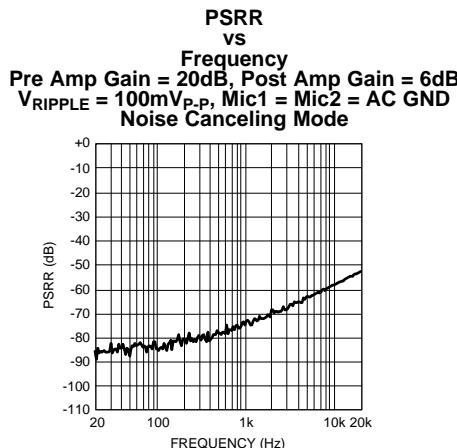


Figure 14.

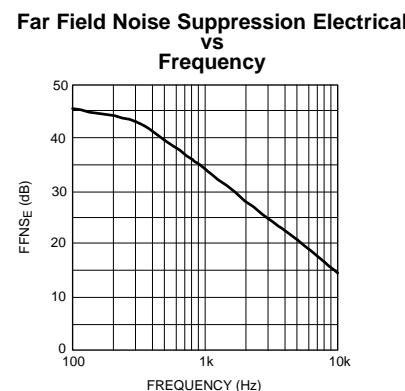


Figure 15.

### Typical Performance Characteristics (continued)

Unless otherwise specified,  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{V}$ , Input Voltage = 18mV<sub>P-P</sub>,  $f = 1\text{ kHz}$ , pass through mode (Note 8), Pre Amp gain = 20dB, Post Amp gain = 6dB,  $R_L = 100\text{k}\Omega$ , and  $C_L = 4.7\text{pF}$ .

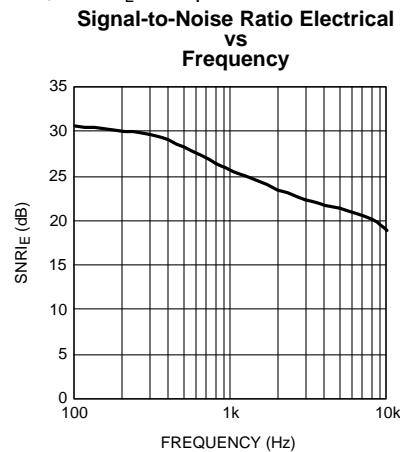
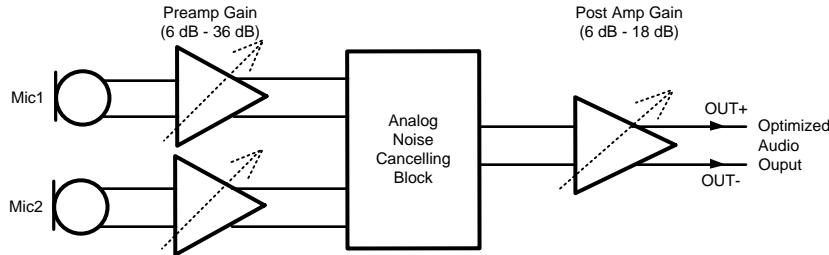


Figure 16.

## APPLICATION DATA

### INTRODUCTION

The LMV1090 is a fully analog single chip solution to reduce the far field noise picked up by microphones in a communication system. A simplified block diagram is provided in [Figure 17](#).



**Figure 17. Simplified Block Diagram of the LMV1090**

The output signal of the microphones is amplified by a pre-amplifier with adjustable gain between 6dB and 36dB. After the signals are matched the analog noise cancelling suppresses the far field noise signal. The output of the analog noise cancelling processor is amplified in the post amplifier with adjustable gain between 6dB and 18dB. For optimum noise and EMI immunity, the microphones have a differential connection to the LMV1090 and the output of the LMV1090 is also differential. The adjustable gain functions can be controlled via I<sup>2</sup>C.

### Power Supply Circuits

A low drop-out (LDO) voltage regulator in the LMV1090 allows the device to be independent of supply voltage variations.

The Power On Reset (POR) circuitry in the LMV1090 requires the supply voltage to rise from 0V to V<sub>DD</sub> in less than 100ms.

The Mic Bias output is provided as a low noise supply source for the electret microphones. The noise voltage on the Mic Bias microphone supply output pin depends on the noise voltage on the internal the reference node. The de-coupling capacitor on the V<sub>REF</sub> pin determines the noise voltage on this internal reference. This capacitor should be larger than 1nF; having a larger capacitor value will result in a lower noise voltage on the Mic Bias output.

Most of the logic levels for the digital control interface are relative to I<sup>2</sup>CV<sub>DD</sub> voltage. This eases interfacing to the micro controller of the application containing the LMV1090. The supply voltage on the I<sup>2</sup>CV<sub>DD</sub> pin must never exceed the voltage on the V<sub>DD</sub> pin.

Only the four pins that determine the default power up gain have logic levels relative to V<sub>DD</sub>.

### Shutdown Function

As part of the Powerwise™ family, the LMV1090 consumes only 0.50mA of current. In many applications the part does not need to be continuously operational. To further reduce the power consumption in the inactive period, the LMV1090 provides two individual microphone power down functions. When either one of the shutdown functions is activated the part will go into shutdown mode consuming only a few  $\mu$ A of supply current.

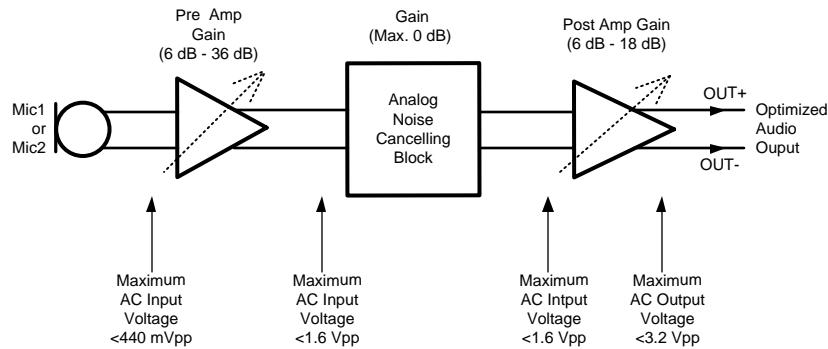
### SHUTDOWN VIA HARDWARE PIN

The hardware shutdown function is operated via the EN pin. In normal operation the EN pin must be at a 'high' level (V<sub>DD</sub>). Whenever a 'low' level (GND) is applied to the EN pin the part will go into shutdown mode disabling all internal circuits.

### Gain Balance and Gain Budget

In systems where input signals have a high dynamic range, critical noise levels or where the dynamic range of the output voltage is also limited, careful gain balancing is essential for the best performance. Too low of a gain setting in the preamplifier can result in higher noise levels while too high of a gain setting in the preamplifier will result in clipping and saturation in the noise cancelling processor and output stages.

The gain ranges and maximum signal levels for the different functional blocks are shown in [Figure 18](#). Two examples are given as a guideline on how to select proper gain settings.



**Figure 18. Maximum Signal Levels**

### Example 1

An application using microphones with  $50\text{mV}_{\text{P-P}}$  maximum output voltage, and a baseband chip after the LMV1091 with  $1.5\text{V}_{\text{P-P}}$  maximum input voltage.

For optimum noise performance, the gain of the input stage should be set to the maximum.

1.  $50\text{mV}_{\text{P-P}} + 36\text{ dB} = 3.1\text{V}_{\text{P-P}}$ .
2.  $3.1\text{V}_{\text{P-P}}$  is higher than the maximum  $1.4\text{V}_{\text{P-P}}$  allowed for the Noise Cancelling Block (NCB). This means a gain lower than 29.5dB should be selected.
3. Select the nearest lower gain from the gain settings shown in Table 4, 28dB is selected. This will prevent the NCP from being overloaded by the microphone. With this setting, the resulting output level of the Pre Amplifier will be  $1.26\text{V}_{\text{P-P}}$ .
4. The NCB has a gain of 0dB which will result in  $1.26\text{V}_{\text{P-P}}$  at the output of the LMV1091. This level is less than maximum level that is allowed at the input of the post amp of the LMV1091.
5. The baseband chip limits the maximum output voltage to  $1.5\text{V}_{\text{P-P}}$  with the minimum of 6dB post amp gain, this results in requiring a lower level at the input of the post amp of  $0.75\text{V}_{\text{P-P}}$ . Now calculating this for a maximum preamp gain, the output of the preamp must be no more than  $0.75\text{V}_{\text{P-P}}$ .
6. Calculating the new gain for the preamp will result in <23.5dB gain.
7. The nearest lower gain will be 22dB.

So using preamp gain = 22dB and postamp gain = 6dB is the optimum for this application.

### Example 2

An application using microphones with  $10\text{mV}_{\text{P-P}}$  maximum output voltage, and a baseband chip after the LMV1090 with  $3.3\text{V}_{\text{P-P}}$  maximum input voltage.

For optimum noise performance we would like to have the maximum gain at the input stage.

1.  $10\text{mV}_{\text{P-P}} + 36\text{dB} = 631\text{mV}_{\text{P-P}}$ .
2. This is lower than the maximum  $1.5\text{V}_{\text{P-P}}$  so this is OK.
3. The NCB has a gain of 0dB which will result in  $1.5\text{V}_{\text{P-P}}$  at the output of the LMV1091. This level is lower than maximum level that is allowed at the input of the Post Amp of the LMV1091.
4. With a Post Amp gain setting of 6dB the output of the Post Amp will be  $3\text{V}_{\text{P-P}}$  which is OK for the baseband.
5. The nearest lower Post Amp gain will be 6dB.

So using preamp gain = 36dB and postamp gain = 6dB is optimum for this application.

## I<sup>2</sup>C Compatible Interface

The LMOV1090 is controlled through an I<sup>2</sup>C compatible serial interface that consists of a serial data line (SDA) and a serial clock (SCL). The clock line are uni-directional. \*The LMOV1090 and the master can communicate at clock rates up to 400kHz. [Figure 19](#) shows the I<sup>2</sup>C Interface timing diagram. Data on the SDA line must be stable during the HIGH period of SCL. The LMOV1090 is a transmit/receive slave-only device, reliant upon the master to generate the SCL signal. Each transmission sequence is framed by a START condition and a STOP condition ([Figure 20](#)). The data line is 8 bits long and is always followed by an acknowledge pulse ([Figure 21](#)).

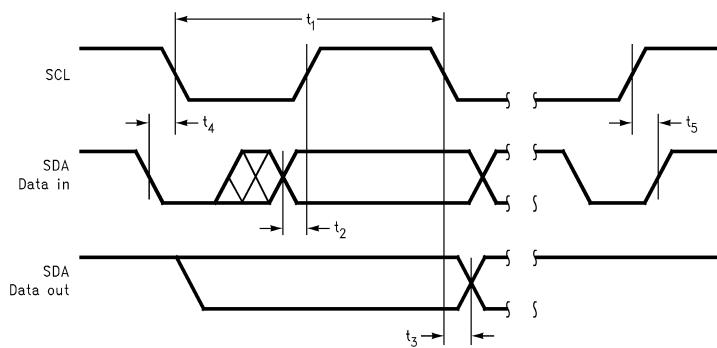
## I<sup>2</sup>C Compatible Interface Power Supply Pin (I<sup>2</sup>CV<sub>DD</sub>)

The LMOV1090 I<sup>2</sup>C interface is powered up through the I<sup>2</sup>CV<sub>DD</sub> pin. The LMOV1090 I<sup>2</sup>C interface operates at a voltage level set by the I<sup>2</sup>CV<sub>DD</sub> pin which can be set independent to that of the main power supply pin V<sub>DD</sub>. This is ideal whenever logic levels for the I<sup>2</sup>C Interface are dictated by a microcontroller or microprocessor that is operating at a lower supply voltage than the main battery of a portable system.

## I<sup>2</sup>C Bus Format

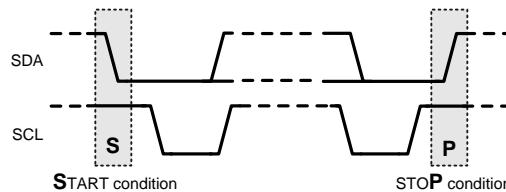
The I<sup>2</sup>C bus format is shown in [Figure 21](#). The START signal, the transition of SDA from HIGH to LOW while SCL is HIGH is generated, alerting all devices on the bus that a device address is being written to the bus. The 7-bit device address is written to the bus, most significant bit (MSB) first followed by the R/W bit, R/W = 0 indicates the master is writing to the slave device, R/W = 1 indicates the master wants to read data from the slave device. Set R/W = 0; the LMOV1090 is a WRITE-ONLY device and will not respond to the R/W = 1. The data is latched in on the rising edge of the clock. Each address bit must be stable while SCL is HIGH. After the last address bit is transmitted, the master device releases SDA, during which time, an acknowledge clock pulse is generated by the slave device. If the LMOV1090 receives the correct address, the device pulls the SDA line low, generating an acknowledge bit (ACK)

Once the master device registers the ACK bit, the 8-bit register data word is sent. Each data bit should be stable while SCL is HIGH. After the 8-bit register data word is sent, the LMOV1090 sends another ACK bit. Following the acknowledgement of the last register data word, the master issues a STOP bit, allowing SDA to go high while SCL is high.



**Figure 19. I<sup>2</sup>C Timing Diagram**

\*The data line is bi-directional (open drain)



**Figure 20. I<sup>2</sup>C Start Stop Conditions**

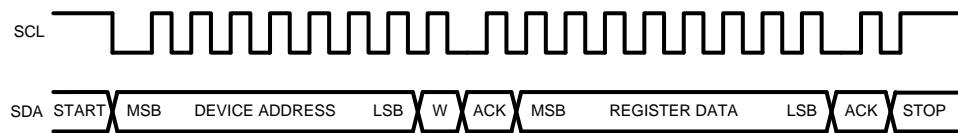


Figure 21. Start and Stop Diagram

Table 1. Chip Address

|              | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0/W |
|--------------|----|----|----|----|----|----|----|------|
| Chip Address | 1  | 1  | 0  | 0  | 1  | 1  | 1  | 0    |

Table 2. I<sup>2</sup>C Register Description

| Address B[7] | Reg. | Bits  | Description |  | Default |  |
|--------------|------|---|-------------|--|---------|--|
|              |      | Gain setting for the pre amplifier from 6dB up to 36dB in 2dB steps |             |  |         |  |
| 0            | A    | 0000  | 6dB         |  | 0000    |  |
|              |      | 0001  | 8dB         |  |         |  |
|              |      | 0010  | 10dB        |  |         |  |
|              |      | 0011  | 12dB        |  |         |  |
|              |      | 0100  | 14dB        |  |         |  |
|              |      | 0101  | 16dB        |  |         |  |
|              |      | 0110  | 18dB        |  |         |  |
|              |      | 0111  | 20dB        |  |         |  |
|              |      | 1000  | 22dB        |  |         |  |
|              |      | 1001  | 24dB        |  |         |  |
|              |      | 1010  | 26dB        |  |         |  |
|              |      | 1011  | 28dB        |  |         |  |
|              |      | 1100  | 30dB        |  |         |  |
|              |      | 1101  | 32dB        |  |         |  |
|              |      | 1110  | 34dB        |  |         |  |
|              |      | 1111  | 36dB        |  |         |  |
|              |      | Gain setting for the post amplifier from 6dB to 18dB in 3dB steps   |             |  |         |  |
|              |      | 000   | 6dB         |  | 000     |  |
|              |      | 001   | 9dB         |  |         |  |
|              |      | 010   | 12dB        |  |         |  |
|              |      | 011   | 15dB        |  |         |  |
|              |      | 100   | 18dB        |  |         |  |
|              |      | 101   | 18dB        |  |         |  |
|              |      | 110   | 18dB        |  |         |  |
|              |      | 111   | 18dB        |  |         |  |
|              |      | 111   | 18dB        |  |         |  |

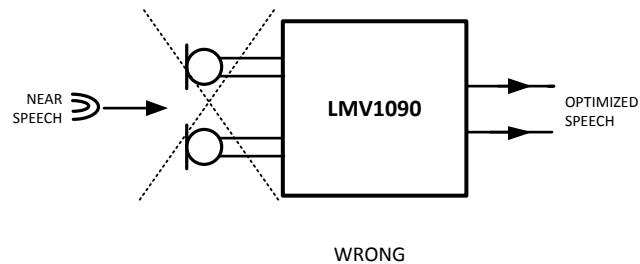
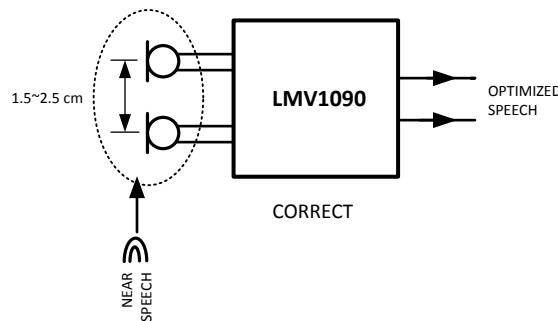
**Table 2. I<sup>2</sup>C Register Description (continued)**

| Address B[7] | Reg. | Bits            | Description   | Default                           |    |  |
|--------------|------|-----------------|---|-----------------------------------|----|--|
| 1            | B    | [1:0]           | B[0] = mute mic 1 and B[1] = mute mic 2<br>( 0 = microphone on)   | 00                                |    |  |
|              |      | [3:2]           | Mic enable bits, B[3] = enable Mic 2, B[2] = enable Mic 1<br>(1 = enable), B3 and B2 both 0 = disable Mic 1 and Mic 2 | 00                                |    |  |
|              |      | Mic select bits |   |                                   |    |  |
|              |      | [5:4]           | 00  | Noise cancelling mode             | 00 |  |
|              |      |                 | 01  | Only Mic 1 enabled (pass through) |    |  |
|              |      |                 | 10  | Only Mic 2 enabled (pass through) |    |  |
|              |      |                 | 11  | Mic 1 + Mic 2                     |    |  |
|              |      | [6]             | Not Used  |                                   |    |  |

## Microphone Placement

Because the LMV1090 is a microphone array Far Field Noise Reduction solution, proper microphone placement is critical for optimum performance. Two things need to be considered: The spacing between the two microphones and the position of the two microphones relative to near field source

If the spacing between the two microphones is too small near field speech will be canceled along with the far field noise. Conversely, if the spacing between the two microphones is large, the far field noise reduction performance will be degraded. The optimum spacing between Mic 1 and Mic 2 is 1.5-2.5cm. This range provides a balance of minimal near field speech loss and maximum far field noise reduction. The microphones should be in line with the desired sound source 'near speech' and configured in an endfire array (see [Figure 23](#)) orientation from the sound source. If the 'near speech' (desired sound source) is equidistant to the source like a broadside array (see [Figure 22](#)) the result will be a great deal of near field speech loss.


**Figure 22. Broadside Array (WRONG)**

**Figure 23. Endfire Array (CORRECT)**

## Low-Pass Filter At The Output

At the output of the LMV1090 there is a provision to create a 1<sup>st</sup> order low-pass filter (only enabled in 'Noise Cancelling' mode). This low-pass filter can be used to compensate for the change in frequency response that results from the noise cancellation process. The change in frequency response resembles a first-order high-pass filter, and for many of the applications it can be compensated by a first-order low-pass filter with cutoff frequency between 1.5kHz and 2.5kHz.

The transfer function of the low-pass filter is derived as:

$$H(s) = \frac{\text{Post Amplifier gain}}{sR_fC_f+1} \quad (2)$$

This low-pass filter is created by connecting a capacitor between the LPF pin and the OUT pin of the LMV1090. The value of this capacitor also depends on the selected output gain. For different gains the feedback resistance in the low-pass filter network changes as shown in [Table 3](#).

This will result in the following values for a cutoff frequency of 2000 Hz:

**Table 3. Low-Pass Filter Capacitor For 2kHz**

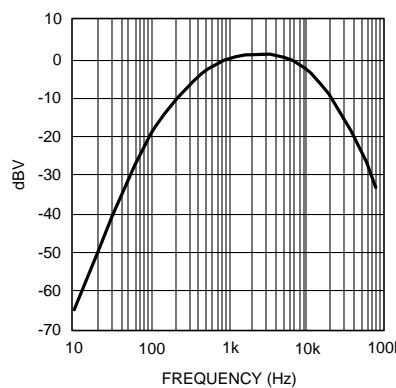
| Post Amplifier Gain Setting (dB) | R <sub>f</sub> (kΩ) | C <sub>f</sub> (nF) |
|----------------------------------|---------------------|---------------------|
| 6                                | 20                  | 3.9                 |
| 9                                | 29                  | 2.7                 |
| 12                               | 40                  | 2.0                 |
| 15                               | 57                  | 1.3                 |
| 18                               | 80                  | 1.0                 |

## A-Weighted Filter

The human ear is sensitive for acoustic signals within a frequency range from about 20Hz to 20kHz. Within this range the sensitivity of the human ear is not equal for each frequency. To approach the hearing response, weighting filters are introduced. One of those filters is the A-weighted filter.

The A-weighted filter is used in signal to noise measurements, where the wanted audio signal is compared to device noise and distortion.

The use of this filter improves the correlation of the measured values to the way these ratios are perceived by the human ear.



**Figure 24. A-Weighted Filter**

## Measuring Noise and SNR

The overall noise of the LMV1090 is measured within the frequency band from 10Hz to 22kHz using an A-weighted filter. The Mic+ and Mic- inputs of the LMV1090 are AC shorted between the input capacitors, see Figure 25.

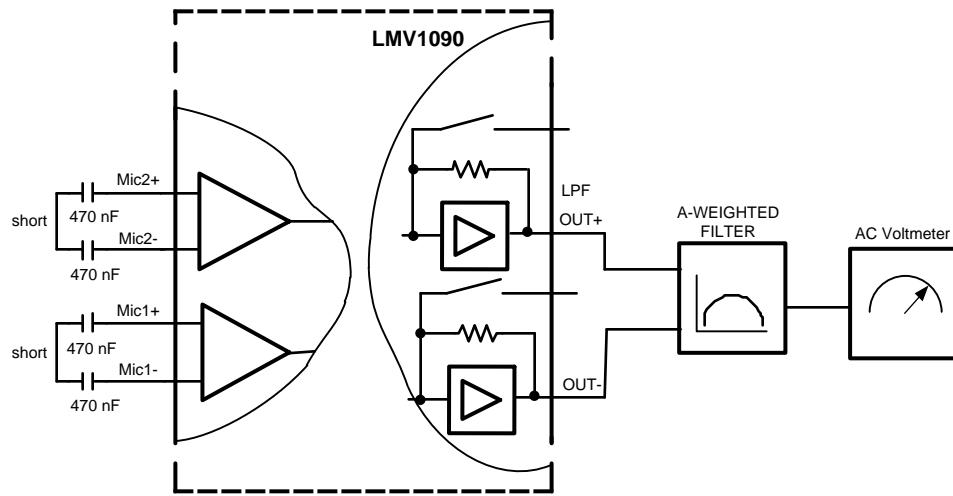


Figure 25. Noise Measurement Setup

For the signal to noise ratio (SNR) the signal level at the output is measured with a 1kHz input signal of  $18\text{mV}_{\text{P-P}}$  using an A-weighted filter. This voltage represents the output voltage of a typical electret condenser microphone at a sound pressure level of 94dB SPL, which is the standard level for these measurements. The LMV1090 is programmed for 26dB of total gain (20dB preamplifier and 6dB postamplifier) with only Mic1 or Mic2 used. (See also [I<sup>2</sup>C Compatible Interface](#)).

The input signal is applied differentially between the Mic+ and Mic-. Because the part is in Pass Through mode the low-pass filter at the output of the LMV1090 is disabled.

**Table 4. Revision History**

| Rev  | Date     | Description  |
|------|----------|--|
| 1.0  | 07/01/09 | Initial released.  |
| 1.01 | 07/10/09 | Deleted the Limit values (on Zin) from both the 3.3V and 5V EC tables. |
| 1.02 | 07/30/09 | Edited the package dimensions (X1, X2, and X3).                        |
| 1.03 | 09/02/09 | Deleted the "Measurement Setup" paragraph.                             |
| 1.04 | 10/12/09 | Text edits.  |
| 1.05 | 10/15/09 | Deleted the input limits on Zin (both from the 3.3V and 5.0V).         |
| 1.06 | 10/29/09 | Text edits.  |
| 1.07 | 07/02/10 | Edited curves 30083357 and 30083358.                                   |
| I    | 05/02/13 | Changed layout of National Data Sheet to TI format                     |

**PACKAGING INFORMATION**

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| LMV1090TL/NOPB        | NRND          | Production           | DSBGA (YZR)   16 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | ZA3                 |
| LMV1090TL/NOPB.A      | NRND          | Production           | DSBGA (YZR)   16 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | ZA3                 |
| LMV1090TLX/NOPB       | NRND          | Production           | DSBGA (YZR)   16 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | ZA3                 |
| LMV1090TLX/NOPB.A     | NRND          | Production           | DSBGA (YZR)   16 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | ZA3                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

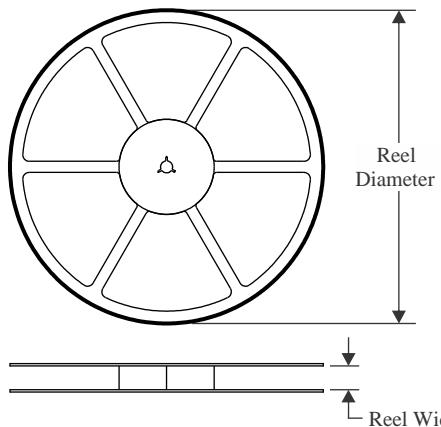
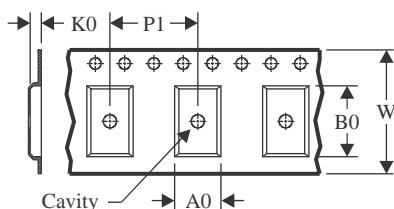
<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

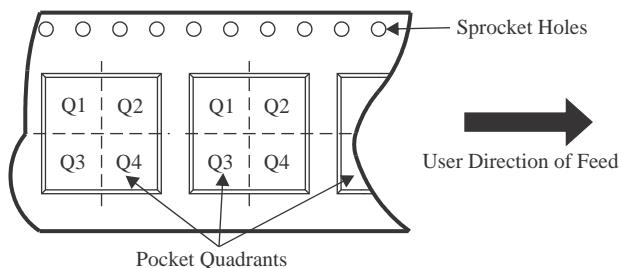
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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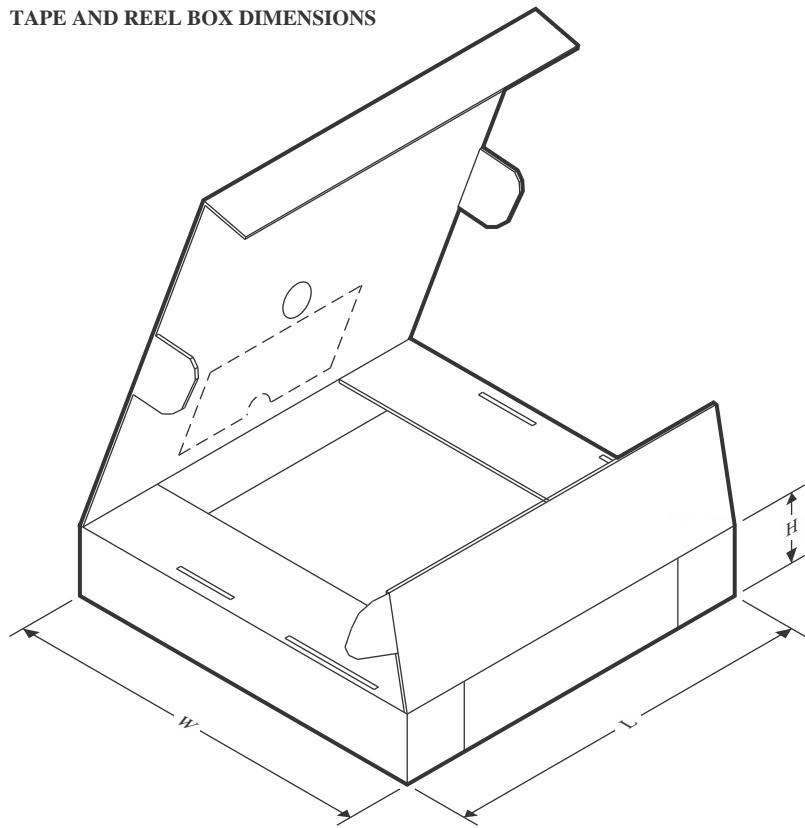
**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


|    |   |
|----|---|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

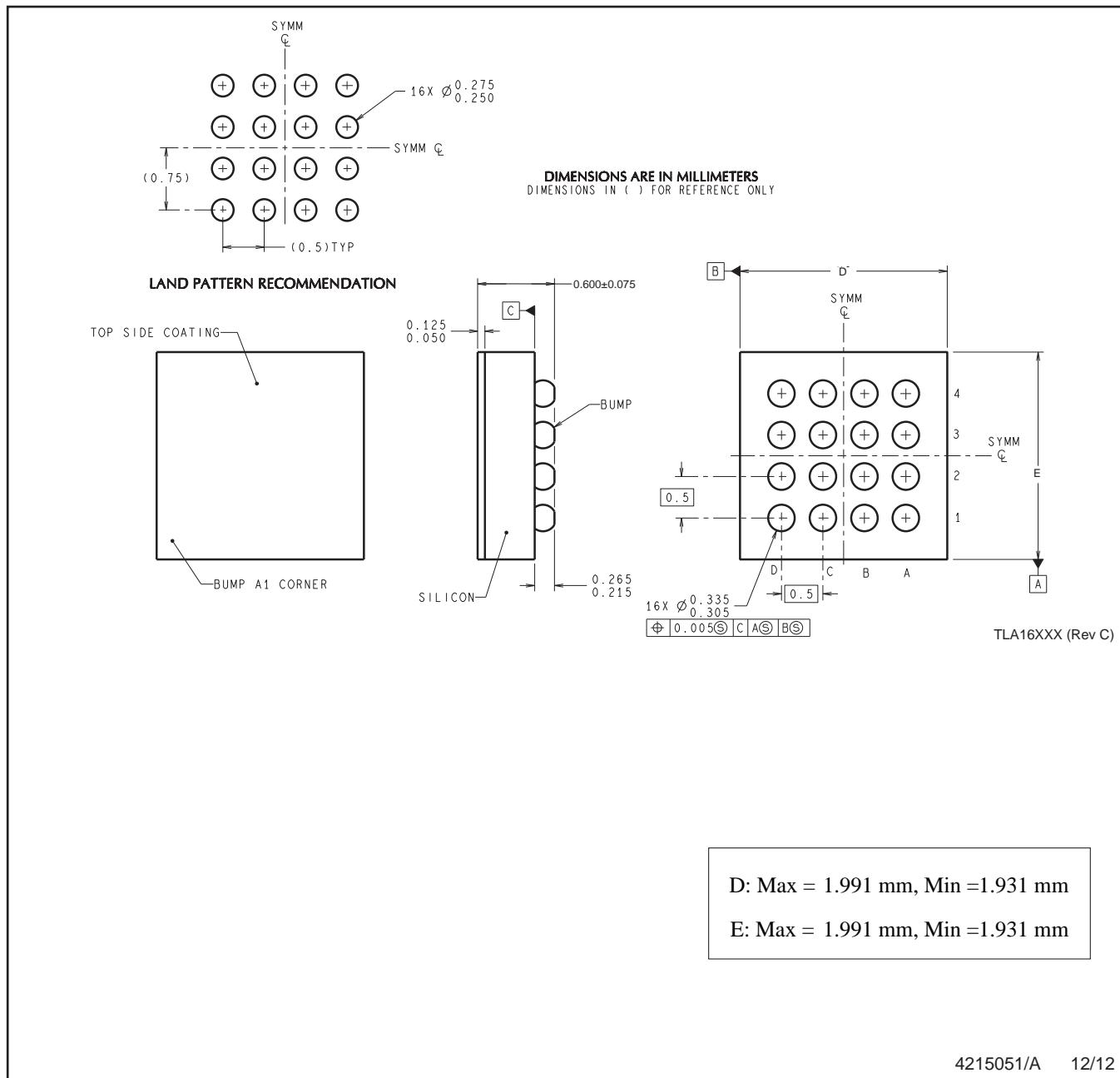
| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LMV1090TL/NOPB  | DSBGA        | YZR             | 16   | 250  | 178.0              | 8.4                | 2.08    | 2.08    | 0.76    | 4.0     | 8.0    | Q1            |
| LMV1090TLX/NOPB | DSBGA        | YZR             | 16   | 3000 | 178.0              | 8.4                | 2.08    | 2.08    | 0.76    | 4.0     | 8.0    | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LMV1090TL/NOPB  | DSBGA        | YZR             | 16   | 250  | 208.0       | 191.0      | 35.0        |
| LMV1090TLX/NOPB | DSBGA        | YZR             | 16   | 3000 | 208.0       | 191.0      | 35.0        |

YZR0016



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.

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